

T1635H Series

Snubberless™ high temperature 16 A Triacs

Main features

Symbol	Value	Unit
I _{T(RMS)}	16	Α
V _{DRM} /V _{RRM}	600	V
I _{GT (Q1)}	35	mA

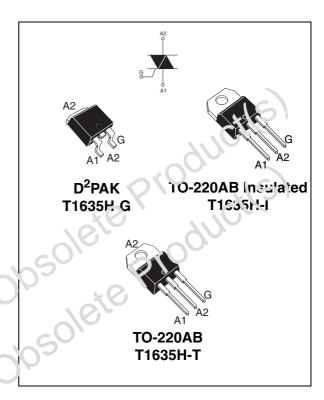
Description

Specifically designed to operate at 150° C, the new 16 A T1635H Triacs provide an enhanced performance in terms of power loss and thermal dissipation. This facilitates the optimization of heatsink dimensioning, leading to improved space and cost effectiveness when compared to electromechanical solutions.

Based on ST Snubberless™ technology, the T1635H series offers high commutation switching capabilities and high noise immunity. Wels on the full range of T_i.

The T1635H series facilitates the optimization of the control of universal maters and inductive loads found in appliances such as vacuum cleaners, and washing machines.

The T1638 H. Triacs are also suitable for use in high temporature environment found in hot appliances such as cookers, ovens, hobs, electric reaters, and coffee machines.



Order code

Part number	Marking
T1635H-600G	T1635H-600G
T1635H-600G-TR	T1635H-600G
T1635H-600TRG	T1635H-600T
T1635H-600IRG	T1635H-600I

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Characteristics T1635H Series

1 Characteristics

Table 1. Absolute maximum ratings

Symbol	Parameter			Value	Unit
I _{T(RMS)}	RMS on-state current (full sine wave)	D ² PAK TO-220AB	T _c = 130° C	16	Α
, ,		TO-220AB Ins	T _c = 110° C		
l	Non repetitive surge peak on-state current	F = 60 Hz	t = 16.7 ms	170	Α
ITSM	(full cycle sine wave, T _j initial = 25° C)	F = 50 Hz	t = 20 ms	160	^
l²t	I ² t Value for fusing	tp = 1	0 ms	128	A ² s
dl/dt	Critical rate of rise of on-state current $I_G = 2xI_{GT}$, tr \leq 100 ns	F = 120 Hz	T _j = 150° C	50	A/µs
V _{DSM} /V _{RSM}	Non repetitive surge peak off state voltage		T _j = 25° C	700	V
I _{GM}	Peak gate current	t _p = 20 μs	$T_j = 750^{\circ} C$	4 (Α
$P_{G(AV)}$	Average gate power dissipation	* 6	T _j = 150° C		W
T _{stg} T _j	Storage junction temperature range Operating junction temperature range	coler	~10 ^d	-40 to +150 -40 to +150	° C

Table 2. Electrical characteristics ($T_j = 25^{\circ}$ G, unique otherwise specified)

Symbol	Test conditions	Quadrant		Value	Unit
I _{GT} ⁽¹⁾	$V_D = 12 \text{ V}, R_L = 33 \Omega$) II - III	MAX	35	mA
V _{GT}	VD = 12 V, 11[= 33 22	11 - 111	MAX	1.3	V
V_{GD}	$V_D = V_{DRM}, R_1 = 3.2 \kappa\Omega$	II - III	MIN	0.15	V
I _H ⁽²⁾	I _T = 107.7A		MAX	35	mA
1.	I _L		MAX	50	mA
16				80	
dV (dt (2)	$V_D = 67\% V_{DRM}$, gate open, $T_j = 150^{\circ} C$			300	V/µs
(aı/dt)c (2)	Without snubber, $T_j = 150^{\circ} C$			7.1	A/ms

^{1.} minimum $I_{\mbox{\scriptsize GT}}$ is guaranteed at 5% of $I_{\mbox{\scriptsize GT}}$ max

2/10

^{2.} for both polarities of A2 referenced to A1

T1635H Series Characteristics

Table 3. Static electrical characteristics

Symbol	Test conditions			Value	Unit
V _{TM} ⁽¹⁾	I _{TM} = 22.5 A, t _p = 380 μs	Tj = 25° C	MAX	1.5	V
V _{TO} (1)		Tj = 150° C	MAX	0.80	V
R _D ⁽¹⁾		Tj = 150° C	MAX	23	mΩ
	$V_{DRM} = V_{RRM}$	Tj = 25° C		5	μΑ
I _{DRM}		Tj = 150° C	MAX	6.4	mA
'NKIVI	$V_D/V_R = 400 \text{ V (at peak mains voltage)}$			4.2	IIIA

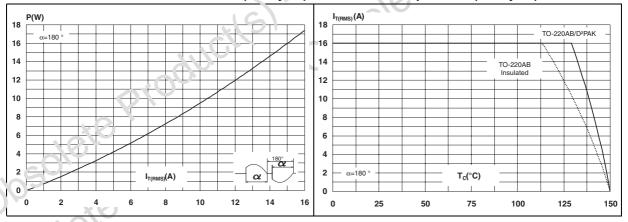
^{1.} for both polarities of A2 referenced to A1

Table 4. Thermal resistance

Symbol	Parameter		Va ue	Unit	
R _{th (j-c)}	Junction to case (AC)		D ² PAK TO-220AB	1.2	
() -/			TO-220AB In 7	2.1	°C/W
		S _{CU} = 1 cm ²	D ² PA.(45	C/VV
R _{th (j-a)}	Junction to ambient	- 6	1つ 210AB 10-220AB Ins	60	

Figure 1. Maximum power dissipation vs RMS on-state current (full cycle)

F gure 2. RMS on-state current vs case temperature (full cycle)



Characteristics T1635H Series

Figure 3. RMS on-state current vs ambient Figure 4. Relative variation of thermal temperature, PCB FR4, $e_{CU} = 35 \mu m$ impedance vs pulse duration

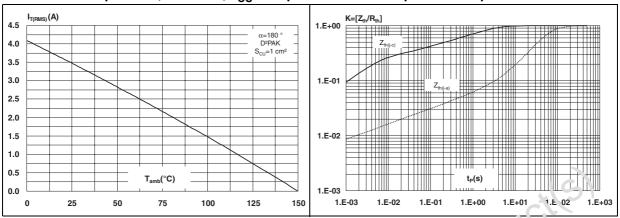


Figure 5. Relative variation of gate trigger current, holding current and latching current vs junction temperature (typical values)

Figure 6. Surge peak on-state current vs number of cycles

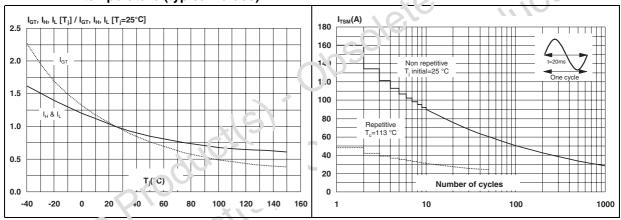
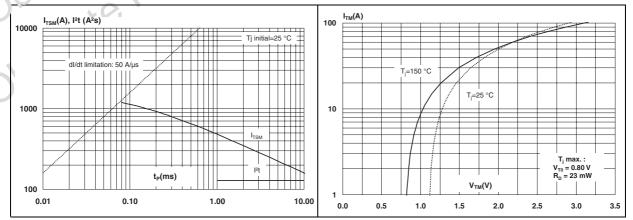


Figure 7. Non repetitive surge peak on-state current (sinusoidal pulse width tp<10 ms) and corresponding value of I²t

Figure 8. On-state characteristics (maximum values)



577

T1635H Series Characteristics

Figure 9. Relative variation of critical rate of decrease of main current (di/dt)c versus junction temperature

Figure 10. Relative variation of critical rate of decrease of main current (di/dt)c vs reapplied dV/dt (typical values)

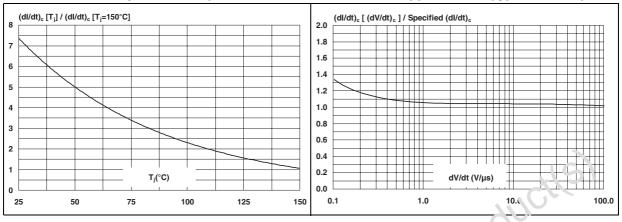


Figure 11. Variation of thermal resistance, junction to ambient versus copper surface under tab (PCB FR4, e_{CU} 35 μm)

Figure 12. Leakage current versus junction temperature for different values of blocking voltage (typical values)

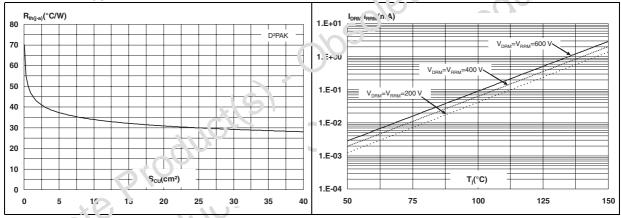
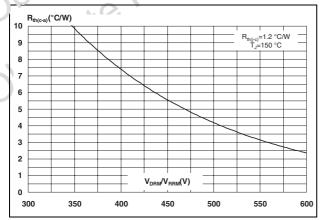
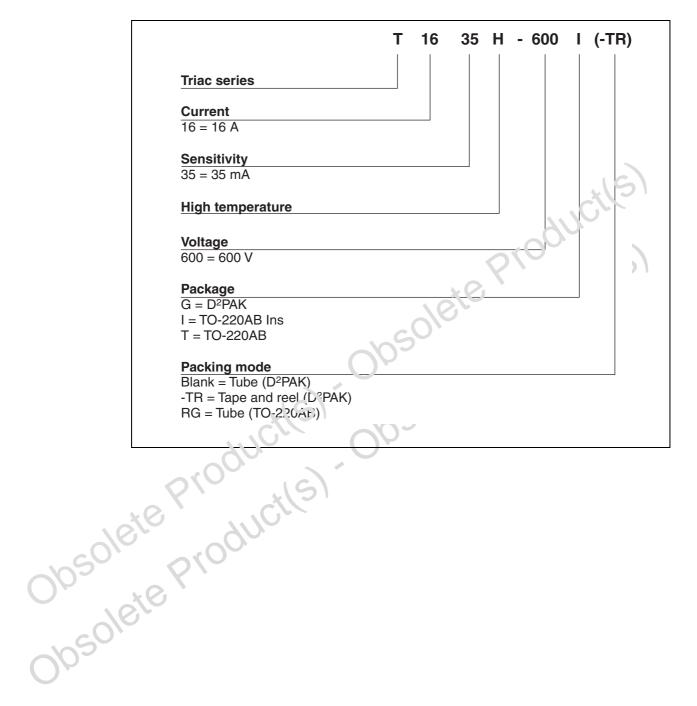


Figure 13. Acceptable repetitive peak off-state voltage versus caseambient thermal resistance



577

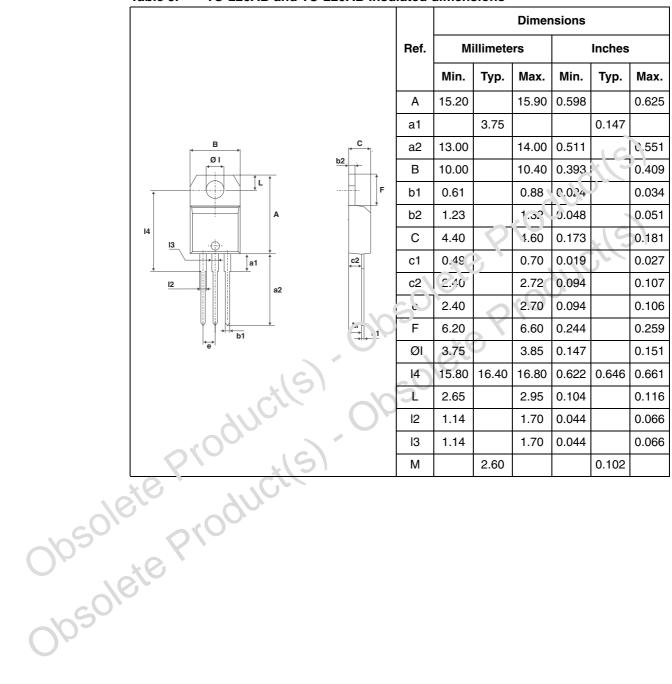
2 Ordering information scheme



T1635H Series Package information

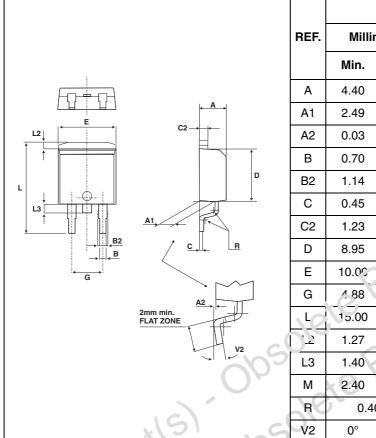
3 Package information

Table 5. TO-220AB and TO-220AB Insulated dimensions



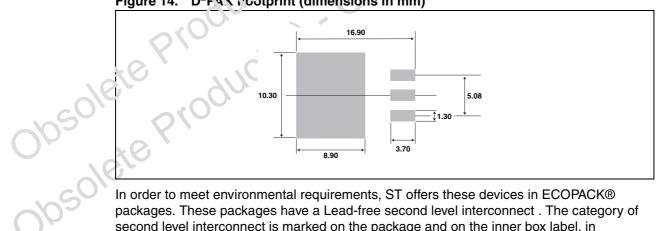
Package information T1635H Series

D²PAK Mechanical data Table 6.



		DIMEN	SIONS		
REF.	Millim	eters	Inches		
	Min.	Max.	Min.	Max.	
Α	4.40	4.60	0.173	0.181	
A1	2.49	2.69	0.098	0.106	
A2	0.03	0.23	0.001	0.009	
В	0.70	0.93	0.027	0.037	
B2	1.14	1.70	0.045	ି 067	
С	0.45	0.60	0.017	1.024	
C2	1.23	1.36	0 043	0.054	
D	8.95	9.35	J.352	0.368	
Е	10.00	10.40	0.393	0.409	
G	1.88	5.28	0.192	0.208	
40	15.00	15.85	0.590	0.624	
2	1.27	1.40	0.050	0.055	
L3	1.40	1.75	0.055	0.069	
М	2.40	3.20	0.094	0.126	
R	0.40 typ.		0.010	6 typ.	
V2	0°	8°	0°	8°	

Figure 14. D²FAX Footprint (dimensions in mm)



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

8/10

Ordering information 4

Part number	Marking	Package	Weight	Base Qty	Packing mode
T1635H-600G	T1635H-600G	D ² PAK	1.5 g	50	Tube
T1635H-600G-TR	T1635H-600G	D ² PAK	1.5 g	1000	Tape and Reel
T1635H-600TRG	T1635H-600T	TO-220AB	2.3 g	50	Tube
T1635H-600IRG	T1635H-600I	TO-220AB Ins	2.3 g	50	Tube

5 **Revision history**

5	Revision h	istory	ducils
	Date	Revision	Changes
	31-Aug-2006	1	Initial release
	Prod	juct(s)	Obsolete Produ
Obsol	ete Prod	MCC	
Opso			

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477